

7-Feb.-19: Save the date !

From layout to chips



# Annual meeting - Preliminary agenda

09:00	Welcome coffee		
09:15-09:25	Introduction	J-Christophe Crébier	CMP
09:25-09:40	2018 activity results	Kholdoun Torki	CMP
09:40-09:55	STMicroelectronics MPW services	Ajith Srivanasan	CMP
09:55-10:15	More Than Moore technologies	Expert presentation	TBC
10:15-10:25	28nm FD-SOI RTL to GDS design flow tutorial, new developments	Christelle Rabache	CMP
10:25-10:40	Flip-chip & Advanced packaging	Lyubomir Kerachev	CMP
10:40-11:05	Break discussion		
11:05-11:20	ams MPW services	Kholdoun Torki	CMP
11:20-11:40	Mature technology services through CMP	Expert presentation	TBC
11:40-12:00	Ultra low power consumption technology services through CMP	Expert presentation	TBC
12:00-12:15	MEMS & Photonics MPW services, MIRPHAB	François Berthollet	CMP
12:15-12:25	NEXTS (EUROPRACTICE)	Kholdoun Torki	CMP
12:25-12:35	myCMP: MPW specialized web application	Alexandre Chagoya	CMP
12:35-12:45	Add-on services	Jérémy Perret	CMP
12:45-12:55	Closing remarks	J-Christophe Crébier	CMP
12:55-14:30	Lunch discussion		